

P6T WS PRO Memory Qualified Vendors List (QVL) BIOS: 0202

P6T WS PRO DDR3 1067 Qualified Vendors List (QVL)

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
CORSAIR	CM3X1024-1066C7	DDR3 1067	1024MB	DS	N/A	Heat-Sink Package	7	1.1	•	•	•	•
Crucial	CT12864BA1067.8SFB	DDR3 1067	1024MB	SS	MICRON	Z9HWQ	7		•	•	•	•
Crucial	CT12864BA1067.8SFD	DDR3 1067	1024MB	SS	MICRON	D9JNL	7		•	•	•	•
Crucial	CT25664BA1067.16SFD	DDR3 1067	2048MB	DS	MICRON	D9JNL	7		•	•	•	•
ELPIDA	EBJ11RD8BAFA-AE-E	DDR3 1067	1024MB	DS	ELPIDA	J5308BASE-AC-E(ECC)	7		•	•	•	•
ELPIDA	EBJ11UD8BAFA-AG-E	DDR3 1067	1024MB	DS	ELPIDA	J5308BASE-AC-E	8		•	•	•	•
Hynix	HMT112U8AFP8C-G7N0	DDR3 1067	1024MB	SS	HYNIX	H5TQ1G831ZNFP-G7	7		•	•	•	•
Hynix	HYMT112U64ZNF8-G7	DDR3 1067	1024MB	SS	HYNIX	H5TQ1G831ZNFP-G7	7		•	•	•	•
Hynix	HMT125U8AFP8C-G7N0	DDR3 1067	2048MB	DS	HYNIX	H5TQ1G831ZNFP-G7	7		•	•	•	•
Hynix	HYMT125U64ZNF8-G7	DDR3 1067	2048MB	DS	HYNIX	H5TQ1G831ZNFP-G7	7		•	•	•	•
KINGSTON	KVR1066D3N7/1G	DDR3 1067	1024MB	DS	ELPIDA	J5308BASE-AC-E		1.5	•	•	•	•
KINGSTON	KVR1066D3N7/2G	DDR3 1067	2048MB	DS	SAMSUNG	K4B1G0846C-ZCF8		1.5	•	•	•	•
MICRON	MT8JTF12864AY-1G1D1	DDR3 1067	1024MB	SS	MICRON	7VD22	7		•	•	•	•
MICRON	MT16JTF25664AY-1G1D1	DDR3 1067	2048MB	DS	MICRON	7VD22	7		•	•	•	•
Qimonda	IMSH1GU03A1F1C-10F	DDR3 1067	1024MB	SS	Qimonda	IDSH1G-03A1F1C-10F	7		•	•	•	•
Qimonda	IMSH1GU03A1F1C-10G	DDR3 1067	1024MB	SS	Qimonda	IDSH1G-03A1F1C-10G	8		•	•	•	•
Qimonda	IMSH2GU13A1F1C-10F	DDR3 1067	2048MB	DS	Qimonda	IDSH1G-03A1F1C-10F	7		•	•	•	•
Qimonda	IMSH2GU13A1F1C-10G	DDR3 1067	2048MB	DS	Qimonda	IDSH1G-03A1F1C-10G	8		•	•	•	•
WINTeC	3DU3191A-10	DDR3 1067	1024MB	DS	Qimonda	IDSH51-03A1F1C-10F	7		•	•	•	•

P6T WS PRO Memory Qualified Vendors List (QVL) BIOS: 0202

P6T WS PRO DDR3 1333 Qualified Vendors List (QVL)

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
CORSAIR	CM3X1024-1333C9DHX	DDR3 1333	1024MB	DS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.1				
CORSAIR	BoxP/N:TWIN3X2048-1333C9 (CM3X1024-1333C9)Ver1.1	DDR3 1333	2048MB(Kit of 2)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.70	•	•	•	•
CORSAIR	BoxP/N:TW3X4G1333C9DHX (CM3X2048-1333C9DHX)Ver3.2	DDR3 1333	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.70	•	•		
Crucial	CT12864BA1339.8SFB	DDR3 1333	1024MB	SS	MICRON	D9GTS	(1333-9-9-9-24)		•		•	•
Crucial	CT25664BA1339.16SFD	DDR3 1333	2048MB	DS	MICRON	D9JNM	(1333-9-9-9-24)		•	•	•	•
ELPIDA	EBJ11UD8BAFA-DG-E	DDR3 1333	1024MB	DS	ELPIDA	J5308BASE-DG-E	(1333-8-8-8-24)		•			
G.SKILL	F3-10600CL7D-2GBPI	DDR3 1333	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1337-7-7-7-18)	1.65	•	•	•	•
G.SKILL	F3-10600CL8D-2GBHK	DDR3 1333	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1337-8-8-8-22)	1.65	•	•	•	•
G.SKILL	F3-10600CL9D-2GBNQ	DDR3 1333	2048MB(Kit of 2)	DS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.5-1.65	•	•	•	•
KINGMAX	FLFD45F-B8EE9	DDR3 1333	1024MB	SS	ELPIDA	J1108BASE-DJ-E	(1333-9-9-9-24)		•	•	•	•
KINGSTON	KVR1333D3N9/1G	DDR3 1333	1024MB	SS	ELPIDA	J1108BASE-DJ-E	(1333-9-9-9-24)	1.5	•	•	•	•
KINGSTON	KVR1333D3N9/2G	DDR3 1333	2048MB	DS	ELPIDA	J1108BASE-DJ-E	(1333-9-9-9-24)	1.5	•	•	•	•
MICRON	MT8JTF12864AY-1G4BYES	DDR3 1333	1024MB	SS	MICRON	Z9HWR	(1333-9-9-9-24)		•			
MICRON	MT16JTF25664AY-1G4BYES	DDR3 1333	2048MB	DS	MICRON	Z9HWR	(1333-9-9-9-24)		•	•	•	•
OCZ	OC23PXP1333EB2GK	DDR3 1333	1024MB	SS	N/A	Heat-Sink Package	(1066-6-5-5-20)		•			
OCZ	OC23P1333ZGK	DDR3 1333	1024MB	DS	N/A	Heat-Sink Package	7-7-7-20(1333-9-9-9-24)		•			
OCZ	OC23P13334GK	DDR3 1333	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7(1333-7-7-7-20)	1.8	•	•	•	•
OCZ	OC23PXP1333EB4GK	DDR3 1333	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	(1066-6-5-5)	1.85	•		•	
Qimonda	IMSH2GU13A1F1C-13H	DDR3 1333	2048MB	DS	Qimonda	IDSH1G-03A1F1C-13H	9(1333-9-9-9-24)		•	•	•	•
SAMSUNG	M378B2873DZ1-CH9	DDR3 1333	1024MB	SS	SAMSUNG	K4B1G0846D	9(1333-9-9-9-24)		•	•	•	•
SAMSUNG	M391B2873DZ1-CH9	DDR3 1333	1024MB	SS	SAMSUNG	K4B1G0846D(ECC)	9(1333-9-9-9-24)		•	•	•	•
SAMSUNG	M378B5673DZ1-CH9	DDR3 1333	2048MB	DS	SAMSUNG	K4B1G0846D	9(1333-9-9-9-24)		•	•	•	•
SAMSUNG	M391B5673DZ1-CH9	DDR3 1333	2048MB	DS	SAMSUNG	K4B1G0846D(ECC)	9(1333-9-9-9-24)		•	•	•	•
Transcend	TS128MLK64V3U	DDR3 1333	1024MB	SS	SAMSUNG	K4B1G0846D	9(1333-9-9-9-24)		•	•	•	•
Transcend	TS256MLK64V3U	DDR3 1333	2048MB	DS	SAMSUNG	K4B1G0846D	9(1333-9-9-9-24)		•	•	•	•
Aeneon	AEH760UD00-13H	DDR3 1333	1024MB	DS	AENEON	AEH93R13H	(1333-9-9-9-24)		•	•	•	•
BUFFALO	FSX1333D3G-1G	DDR3 1333	1024MB	SS	N/A	Heat-Sink Package	(1066-7-7-7-20)		•	•	•	•
BUFFALO	FSX1333D3G-2G	DDR3 1333	2048MB	DS	N/A	Heat-Sink Package	(1066-7-7-7-20)		•	•	•	•
Elilixir	M2F2G64C8BH4N-CG	DDR3 1333	2048MB	DS	Elilixir	N2CB1G80AN-CG	(1333-9-9-9-24)		•	•	•	•
Patriot	PDC32G1333LLK	DDR3 1333	1024MB	SS	PATRIOT	Heat-Sink Package	7(1337-7-7-7-20)	1.7	•	•	•	•

P6T WS PRO Memory Qualified Vendors List (QVL) BIOS: 0202

P6T WS PRO DDR3 1600 Qualified Vendors List (QVL)

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
CORSAIR	BoxP/N:TWIN3X4096-1600C7DHXIN	DDR3 1600	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	(1601-7-7-7-20)	1.90	•	•	•	•
Crucial	BL12864BA1608.8SFB(XMP)	DDR3 1600	1024MB	SS	N/A	Heat-Sink Package	(1601-8-8-8-24)	1.8	•	•	•	•
G.SKILL	F3-12800CL7D-2GBBHZ	DDR3 1600	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1601-7-7-7-18)	1.9	•	•	•	•
G.SKILL	F3-12800CL7D-4GBPI	DDR3 1600	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-7-18(1333-9-9-9-24)	1.9	•	•	•	•
KINGSTON	KHX12800D3K2/4G	DDR3 1600	4096MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1066-7-7-7-20)	1.9				
OCZ	OC23P1600EB1G	DDR3 1600	1024MB	SS	N/A	Heat-Sink Package	7-6-6-24(1333-7-7-7-20)		•			
OCZ	OC23P1600XM2GK(XMP)	DDR3 1600	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	(1601-8-8-8-28)		•	•	•	•
OCZ	OC23P1600EB4GK	DDR3 1600	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	7-7-6(1333-7-7-7-20)	1.8	•		•	
Aeneon	AXH760UD10-16H	DDR3 1600	1024MB	SS	N/A	Heat-Sink Package	(1601-9-9-9-28)		•	•	•	•
Aeneon	AXH860UD20-16H	DDR3 1600	2048MB	DS	N/A	Heat-Sink Package	(1601-9-9-9-28)		•	•	•	•
Team	BoxP/N:TXD32048M1600HC7DC (TXD31024M1600HC7)	DDR3 1600	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	7-7-7-21(1333-8-8-824)	1.75-1.85	•		•	

P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0409

P6T WS PRO DDR3 1067 Qualified Vendors List (QVL)

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
Crucial	CT12864BA1067.8SFB	DDR3 1067	1024MB	SS	MICRON	Z9HWQ	7					•

P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0409

P6T WS PRO DDR3 1333 Qualified Vendors List (QVL)

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
A-DATA	AD31333E002G0U	DDR3 1333	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	7-7-7-20(1333-9-9-9-24)	1.65-1.85	•	•	•	•
CORSAIR	TR3X3G1333C9 (Ver2.1)	DDR3 1333	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.5	•	•	•	•
CORSAIR	TR3X6G1333C9 (Ver2.1)	DDR3 1333	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.5	•	•	•	•
OCZ	OC23X13333GK	DDR3 1333	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	7-7-7(1066-6-6-6-16)	1.6	•	•		
OCZ	OC23P1333LV6GK	DDR3 1333	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9(1066-7-7-7-20)	1.65	•	•		
OCZ	OC23P1333LV6GK	DDR3 1333	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	7-7-7(1066-7-7-7-20)	1.65	•	•	•	
Patriot	PVT3G1333ELK	DDR3 1333	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.65	•	•	•	•
Patriot	PVT36G1333ELK	DDR3 1333	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	1.65	•	•	•	•

P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0409

P6T WS PRO DDR3 1600 Qualified Vendors List (QVL)

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
A-DATA	AD31600E001GMU(XMP)	DDR3 1600	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	8-8-8-24(1333-9-9-9-24)	1.65-1.85	•	•	•	•
A-DATA	AD31600F002GMU(XMP)	DDR3 1600	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	7-7-7-20(1333-9-9-9-24)	1.75-1.85	•	•	•	•
CORSAIR	TR3X6G1600C9(XMP)Ver1.1	DDR3 1600	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1601-9-9-9-24)	1.65				
CORSAIR	TR3X6G1600C8(XMP)Ver2.1	DDR3 1600	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8-24(1601-8-8-8-24)	1.65				
CORSAIR	TR3X6G1600C9(XMP)Ver2.1	DDR3 1600	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1333-9-9-9-24)	1.65	•		•	•
KINGSTON	KHX12800D3LLK3/3G(XMP)	DDR3 1600	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.65		•		
OCZ	OC23G1600LV3GK	DDR3 1600	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	8-8-8(1066-7-7-7-20)	1.65	•	•	•	•
OCZ	OC23G1600LV6GK	DDR3 1600	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	8-8-8(1066-7-7-7-20)	1.65				•

P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0409

P6T WS PRO DDR3 1800 Qualified Vendors List (QVL)

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
KINGSTON	KHX14400D3K3/3GX(XMP)	DDR3 1800	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.65	•	•		

P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0409

P6T WS PRO DDR3 1866 Qualified Vendors List (QVL)

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
KINGSTON	KHX14900D3K3/3GX(XMP)	DDR3 1866	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.65	•	•		
Aeneon	AXH860UD20-18J(XMP)	DDR3 1866	2048MB	DS	N/A	Heat-Sink Package	10(1333-8-8-8-24)		•	•	•	

P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0409

P6T WS PRO DDR3 2000 Qualified Vendors List (QVL)

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
KINGSTON	KHX16000D3K3/3GX(XMP)	DDR3 2000	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.65	•	•	•	

P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0702

P6T WS PRO DDR3 1800 Qualified Vendors List (QVL)

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
Apacer	78.0AGCB-CDZ(XMP)	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1800-8-8-8-24)	1.8	•	•	•	
Apacer	BoxP/N:DH.02GAL.F7LK2 (78.0AGCB.BN0)	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	7-7-7-20		•			
CORSAIR	CM3X1024-1800C7DIN(XMP)	DDR3 1800	1024MB	SS	N/A	Heat-Sink Package	7		•	•	•	
CORSAIR	BoxP/N:TW3X4G1800C8DF (CM3X2G1800C8D)Ver4.1	DDR3 1800	4096MB(Kit of 2)	DS	N/A	Heat-Sink Package	8-8-8-24	1.80	•			
KINGSTON	KHX14400D3/1G	DDR3 1800	1024MB	SS	N/A	Heat-Sink Package		1.9	•	•	•	
KINGSTON	KHX14400D3K2/2G	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		1.9	•	•		
KINGSTON	KHX14400D3K2/2GN(EPP)	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		1.9	•	•		
KINGSTON	KHX14400D3K3/3GX(XMP)	DDR3 1800	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	1800-9-9-9-27	1.65	•	•	•	
OCZ	OCZ3P18002GK	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8		•	•	•	•
Transcend	TX1800KLU-2GK(XMP)	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8		•	•		
Patriot	PVS32G1800LLKN(EPP)	DDR3 1800	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-20(1066-7-7-7-20)	1.9	•	•	•	•

P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0702

P6T WS PRO DDR3 1866 Qualified Vendors List (QVL)

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
CORSAIR	TR3X3G1866C9D(XMP)	DDR3 1866	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(1866-9-9-9-24)	1.65	•	•	•	
CORSAIR	TR3X6G1866C9D	DDR3 1866	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9-24(1866-9-9-9-24)	1.65	•	•	•	•
KINGSTON	KHX14900D3K3/3GX(XMP)	DDR3 1866	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.65	•	•		
OCZ	OCZ3P1866C9LV6GK	DDR3 1866	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9(1066-7-7-7-20)	1.65	•	•	•	•
OCZ	OCZ3RPR1866C9LV6GK	DDR3 1866	6144MB(Kit of 3)	DS	N/A	Heat-Sink Package	9-9-9(1066-7-7-7-20)	1.65	•	•	•	
Super Talent	W1866UX2GB(XMP)	DDR3 1866	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1333-9-9-9-24)		•	•	•	•
Patriot	PVS32G1866LLK(XMP)	DDR3 1866	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1066-7-7-7-20)	1.9	•	•	•	
Patriot	PVS32G1866LLK(XMP)	DDR3 1866	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8-8-8-24(1866-8-8-8-24)	1.9	•	•	•	

P6T WS PRO Memory Qualified Vendors List (QVL) BIOS:0702

P6T WS PRO DDR3 2000 Qualified Vendors List (QVL)

Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
CORSAIR	BoxP/N:TW3X2G2000DFNV (CM3X1G2000DFNV)(EPP)Ver3.1	DDR3 2000	2048MB(Kit of 2)	DS	N/A	Heat-Sink Package	8-8-8-24	1.9	•	•	•	
Crucial	BL12964BE2009.85FB3(EPP)	DDR3 2000	1024MB	SS	N/A	Heat-Sink Package	9-9-9-28(1333-9-9-9-24)	2	•			•
G.SKILL	F3-16000CL9T-3GBDI-B(XMP)	DDR3 2000	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	9-9-9-24(2000-9-9-9-24)	1.65	•	•		
KINGSTON	KHX16000D3K2/2GN(EPP)	DDR3 2000	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package		2.0	•	•	•	
KINGSTON	KHX16000D3K3/3GX(XMP)	DDR3 2000	3072MB(Kit of 3)	SS	N/A	Heat-Sink Package	(1333-9-9-9-24)	1.65	•	•	•	
OCZ	OCZ3FXT20002GK	DDR3 2000	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	8	1.9	•			
Gingple	9CAASS37AZ01D1	DDR3 2000	2048MB	DS	N/A	Heat-Sink Package	9-9-9-24		•	•	•	
Patriot	PVS32G2000LLKN	DDR3 2000	2048MB(Kit of 2)	SS	N/A	Heat-Sink Package	9-9-9-24(1066-7-7-7-20)	2	•	•		

6 Dimm :

- A*: Supports two (2) modules inserted into slot A1 and B1 as one pair of Dual-channel memory configuration
- B*: Supports three (3) modules inserted into the orange slots (A1, B1 and C1) as one set of Triple-channel memory configuration
- C*: Supports four (4) modules inserted into the orange slots (A1, B1 and C1) and the black slot A2 as one set of Triple-channel memory configuration
- D*: Supports six (6) modules inserted into both the orange slots and the black slots as two set of Triple-channel memory configuration.

-When installing total memory of 4GB capacity or more, Windows 32-bit operation system may only recognize less than 3GB. Hence, a total installed memory of less than 3GB is recommended.

-It is recommended to install the memory modules from the slots for better overclocking capability.

-The default DIMM frequency depends on its Serial Presence Detect (SPD), which is the standard way of accessing information from a memory module. Under the default state, some memory modules for overclocking may operate at a lower frequency than the vendor-marked value.